AMENDMENTS TO THE CLAIMS

- 1-10. (Canceled)
- 11. (Currently amended) A non-volatile memory cell comprising:
- a germanium selenide glass doped with comprising silver, said silver doping being in a concentration which maintains said germanium selenide glass in the glass forming region having the formula (Ge_xSe_{1-x})_{1-y}Ag_y, wherein 39≤x≤42 and y corresponds to a stoichiometric amount of silver suitable to maintain said germanium selenide glass in a non-crystalline state; and
- a first electrode and a second electrode in contact with electrically coupled to said doped germanium selenide glass; and.
- a dendrite formed between said first and second electrodes when voltage is applied to said first and second electrodes.
- 12-23. (Canceled)
- 24. (Currently amended) A memory cell comprising:
- a germanium selenide glass comprising silver, said germanium selenide glass having the formula (GexiSe1-x1)1-y1Agy1 (GexSe1-x)1-yAgy, wherein 18≤x1 x ≤28 and wherein said silver is in a concentration which maintains said germanium selenide glass in the glass forming region y corresponds to a stoichiometric amount of silver suitable to maintain said germanium selenide glass in a non-crystalline state; and[[,]]
- at least two electrodes in contact with <u>electrically coupled to</u> said germanium selenide glass, said germanium selenide glass forming a dendrite between at

least two electrodes in response to a voltage applied across said at least two electrodes.

- 25. (Currently amended) A memory cell comprising:
- a germanium selenide glass having the formula (Gex2Se1x2)1-y2Agy2 (GexSe1-x)1-yAgy, wherein $39 \le x2 \le 42 \times 10^{-2} \times 10^$
- at least two electrodes in contact with electrically coupled to said germanium selenide glass, said germanium selenide glass forming a dendrite between at least two electrodes in response to a voltage applied across said at least two electrodes.
- 26. (Canceled)
- 27. (Currently amended) A method of forming a memory cell comprising the steps of:
- providing a germanium selenide glass having the formula (Gex2Se1+x2)1-y2Agy2

 (GexSe1-x)1-yAgy, wherein 18≤x1 x ≤28 over a substrate, and wherein said silver
 is in a concentration which maintains y corresponds to a stoichiometric

 amount of silver suitable to maintain said germanium selenide glass in the
 glass forming region a non-crystalline state; and[[,]]
- forming at least two electrodes in contact with electrically coupled to said germanium selenide glass at locations which permit said glass to transition

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between high and low resistance states in response to signals applied to said electrodes.

- 28. (Currently amended) The method of claim 27, wherein x=23.
- 29. (Currently amended) The method of claim 27, wherein x₁=25.
- 30. (Currently amended) The method of claim 27, wherein x₁=20.
- 31. (Currently amended) A method of forming a memory cell, comprising the steps of:
- providing a germanium selenide glass having the formula $(Ge_{*2}Se_{1*2})_{1:y2}Ag_{y2}$ $(Ge_{*}Se_{1*2})_{,}$ wherein $39 \le *_2 x \le 42$; and wherein said silver is in a concentration which maintains adding an amount of silver to said germanium selenide glass corresponding to a stoichiometric amount suitable to maintain said germanium selenide glass in the glass forming region a non-crystalline state; and,
- forming providing at least two electrodes in contact with electrically coupled to said germanium selenide glass at locations which permit said glass to transition between high and low resistance states in response to signals applied to said electrodes said electrodes to apply bipolar charge across said germanium selenide glass.
- 32. (Currently amended) A method of operating a memory cell, comprising the steps of:
- applying a voltage across a germanium selenide glass having the formula $(Ge_{xi}Se_{1\cdot xi})_{1\cdot yi}Ag_{yi}$ $(Ge_{x}Se_{1\cdot x})_{1\cdot yi}Ag_{yi}$ wherein $18 \le x_i \le 28$ and wherein said silver is in a concentration which maintains y corresponds to a stoichiometric

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amount of silver suitable to maintain said germanium selenide glass in the glass forming region a non-crystalline state, to change the said voltage application changing a resistance state of said glass.

- 33. (Currently amended) The method of claim 32, wherein x=23.
- 34. (Currently amended) The method of claim 32, wherein x=25.
- 35. (Currently amended) The method of claim 32, wherein x=20.
- 36. (Currently amended) A method of operating a memory cell, comprising the steps of:
- applying a voltage across a germanium selenide glass having the formula $(Ge_{\times 2}Se_{1\times 2})_{1\cdot y^2}Ag_{y^2}$ $(Ge_{\times}Se_{1\cdot x})_{1\cdot y}Ag_{y}$, wherein $39 \le x_2 \le 42$ and wherein said silver is in a concentration which maintains y corresponds to a stoichiometric amount of silver suitable to maintain said germanium selenide glass in the glass forming region a non-crystalline state, to change the said voltage application changing a resistance state of said glass.
- 37. (Currently amended) A processor system comprising:
- a processor; and
- an integrated circuit coupled to said processor, at least one of said processor and integrated circuit including a memory cell, said memory cell comprising:
- a germanium selenide glass having the formula $(Ge_{*i}Se_{1*i})_{1:yi}Ag_{yi}$ $(Ge_{*i}Se_{1:x})_{1:yi}Ag_{yi}$ $(Ge_{*i}Se_{1:x})_{1:yi}Ag_{yi}$ wherein $18 \le x_1 \le 28$ and wherein said silver is in a concentration which maintains y corresponds to a stoichiometric amount of silver suitable to maintain said germanium selenide glass in the glass forming region a non-

crystalline state; and

at least two electrodes in contact with electrically coupled to said doped germanium selenide glass, said germanium selenide glass changing a resistance state in response to application of a voltage across said at least two electrodes.

- 38. (Original) The processor system of claim 37, wherein said processor and said integrated circuit are integrated on same chip.
- 39. (Currently amended) The processor system of claim 37, wherein x_4 =23.
- 40. (Currently amended) The processor system of claim 37, wherein $x_1=25$.
- 41. (Currently amended) The processor system of claim 37, wherein $x_1=20$.
- 42. (Currently amended) A processor system comprising:
- a processor; and
- an integrated circuit coupled to said processor, at least one of said processor and integrated circuit including a memory cell, said memory cell comprising:
- a germanium selenide glass having the formula $(Ge_{\times 2}Se_{1 \times 2})_{1 \cdot y2}Ag_{y2}$ $(Ge_{\times}Se_{1 \times 2})_{1 \cdot y2}Ag_{y2}$ $(Ge_{\times}Se_{1 \times 2})_{1 \cdot y2}Ag_{y2}$ ($Ge_{\times}Se_{1 \times 2}$) ($Ge_{\times}Se$
- at least two electrodes in contact with electrically coupled to said doped germanium selenide glass, said germanium selenide glass changing a

resistance state in response to application of a voltage across said at least two electrodes.

43. (Original) The processor-based system of claim 42, wherein said processor and said integrated circuit are integrated on same chip.